

CO402C221GATACTU

Aliases (C0402C221GATAC7867)

SMD Comm X8G HT150C, Ceramic, 220 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	1.06 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
Т	0.5mm +/-0.05mm
S	0.3mm MIN
В	0.3mm +/-0.1mm

I	0.5mm +/-0.05mm
S	0.3mm MIN
В	0.3mm +/-0.1mm
Packaging Specifications	

	Specifications		
	Capacitance	220 pF	
	Measurement Condition	1 MHz 1.0Vrms	
	Tolerance	2%	
	Voltage DC	250 VDC	
	Dielectric Withstanding Voltage	625 VDC	
	Temperature Range	-55/+150°C	
	Temp. Coefficient	X8G	
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms	
	Dissipation Factor	0.1% 1 MHz 1.0Vrms	
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
	Insulation Resistance	100 GOhms	

Packaging	T&R, 180mm, Paper Tape	Applied (TCC)	
Packaging Quantity	10000	Dissipation Factor	O.1% 1 MH
		Aging Rate	0% Loss

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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